

July 2007

EGP30A - EGP30K

3.0 Ampere Glass Passivated High Efficiency Rectifiers

Features

- Glass passivated cavity-free junction
- · High surge current capability
- · Low leakage current
- · Superfast recovery time for high efficiency
- · Low forward voltage, high current capability



DO-201AD Glass case COLOR BAND DENOTES CATHODE

Absolute Maximum Ratings* $T_a = 25$ °C unless otherwise noted

Symbol	Parameter	Value	Units
I _O	Average Rectified Current .375 " lead length @ TL= 55°C	3.0	А
İ _f (surge)	Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	125	А
P _D	Total Device Dissipation Derate above 25°C	6.25 50	W mW°C
Reja	Thermal Resistance, Junction to Ambient	20	°C/W
ReJL	Thermal Resistance, Junction to Lead	8.5	°C/W
T _J , T _{STG}	Junction and Storage Temperature Range	-65 ~ 150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

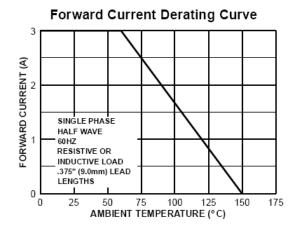
Electrical Characteristics* T_a = 25°C unless otherwise noted

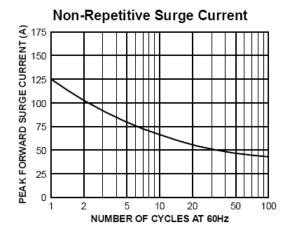
	Device								
Parameter	30A	30B	30C	30D	30F	30G	30J	30K	Units
Peak Repetitive Reverse Voltage	50	100	150	200	300	400	600	800	V
Maximum RMS Voltage	35	70	105	140	210	280	420	560	V
DC Reverse Voltage (Rated VR)	50	100	150	200	300	400	600	800	V
Maximum Reverse Current @ rated VR TA = 25°C TA = 125°C	5.0 100							μ Α μ Α	
Maximum Reverse Recovery Time IF = 0.5 A, IR = 1.0 A, Irr = 0.25 A	50 75							nS	
Maximum Forward Voltage @ 3.0 A	0.95				1.25		1	.7	V
Typical Junction Capacitance VR = 4.0 V, f = 1.0 MHz		95 75						pF	

^{*} Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%

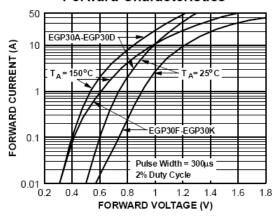
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Typical Performance Characteristics

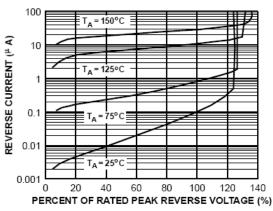




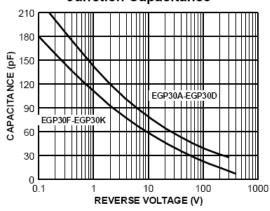
Forward Characteristics



Reverse Characteristics



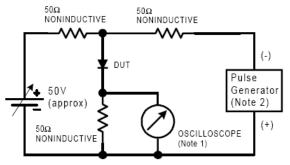
Junction Capacitance



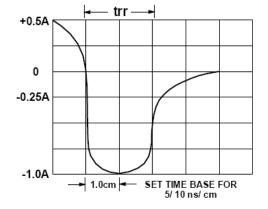
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Reverse Recovery Time Characterstic and Test Circuit Diagram



- Rise time = 7.0 ns max; Input impedance = 1.0 megaohm 22 pf.
 Rise time = 10 ns max; Source impedance = 50 ohms.



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